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Features

- Max $r_{DS(on)} = 6 \text{ m}\Omega$ at $V_{GS} = 10 \text{ V}$, $I_D = 14 \text{ A}$
- Max $r_{DS(on)} = 11 \text{ m}\Omega$ at $V_{GS} = 6 \text{ V}$, $I_D = 11.5 \text{ A}$
- Advanced Package and Silicon combination for low r_{DS(on)} and high efficiency
- MSL1 robust package design
- 100% UIL tested
- RoHS Compliant

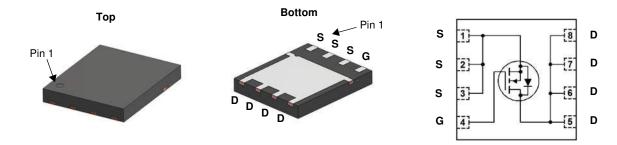


General Description

This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced Power Trench[®] process thant has been especially tailored to minimize the on-state resistance and yet maintain superior switching performance.

Applications

- Primary DC-DC MOSFET
- Secondary Synchronous Rectifier
- Load Switch



Power 56

MOSFET Maximum Ratings T_A = 25 °C unless otherwise noted

Symbol	Parameter			Ratings	Units	
V _{DS}	Drain to Source Voltage			100	V	
V _{GS}	Gate to Source Voltage			±20	V	
I _D	Drain Current -Continuous	T _C = 25 °C		45		
	-Continuous	T _A = 25 °C	(Note 1a)	14	Α	
	-Pulsed			260		
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	541	mJ	
P _D	Power Dissipation $T_{\rm C} = 25 ^{\circ}{\rm C}$			125	w	
	Power Dissipation	T _A = 25 °C	(Note 1a)	2.7	v	
T _J , T _{STG}	Operating and Storage Junction Temperature Range			-55 to +150	°C	

Thermal Characteristics

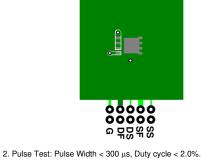
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	1.0	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient (Note	1a) 45	C/ VV

Package Marking and Ordering Information

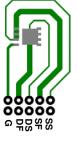
Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMS86152	FDMS86152	Power 56	13 "	12 mm	3000 units

March 2015

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	cteristics					4
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = 250 μA, V _{GS} = 0 V	100			V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		90		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 80 V, V _{GS} = 0 V			1	μA
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 20 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$			±100	nA
On Chara	cteristics					1
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \ \mu A$	2	3	4	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		-10		mV/°C
		V _{GS} = 10 V, I _D = 14 A		5.2	6	mΩ
r _{DS(on)}	Static Drain to Source On Resistance	V _{GS} = 6 V, I _D = 11.5 A		7.3	11	
		V _{GS} = 10 V, I _D = 14 A, T _J = 125 °C		8.7	10	
9 _{FS}	Forward Transconductance	V _{DS} = 10 V, I _D = 14 A		42		S
C _{iss} C _{oss} C _{rss}	Output Capacitance Reverse Transfer Capacitance	$V_{DS} = 50 V, V_{GS} = 0 V,$ f = 1 MHz		595 22	795 35	pF
R _g	Gate Resistance			0.9		Ω
Switching	g Characteristics					
t _{d(on)}	Turn-On Delay Time			17	30	ns
t _r	Rise Time	V _{DD} = 50 V, I _D = 14 A,		6	12	ns
t _{d(off)}	Turn-Off Delay Time	V_{GS} = 10 V, R_{GEN} = 6 Ω		25	39	ns
t _f	Fall Time			5	10	ns
Qg	Total Gate Charge	$V_{GS} = 0 V$ to 10 V		36	50	nC
Qg	Total Gate Charge	$V_{GS} = 0 V \text{ to } 6 V$ $V_{DD} = 50 V$,		23	33	nC
Q _{gs}	Gate to Source Charge	I _D = 14 A		10.7		nC
Q _{gd}	Gate to Drain "Miller" Charge			7.2		nC
Drain-Soເ	urce Diode Characteristics					
		$V_{GS} = 0 V, I_S = 2.1 A$ (Note 2)		0.70	1.2	- V
V _{SD}		$V_{GS} = 0 V, I_S = 14 A$ (Note 2)		0.78	1.3	
t _{rr}	Reverse Recovery Time			59	94	ns
Q _{rr}	Reverse Recovery Charge	— I _F = 14 A, di/dt = 100 A/μs		74	119	nC

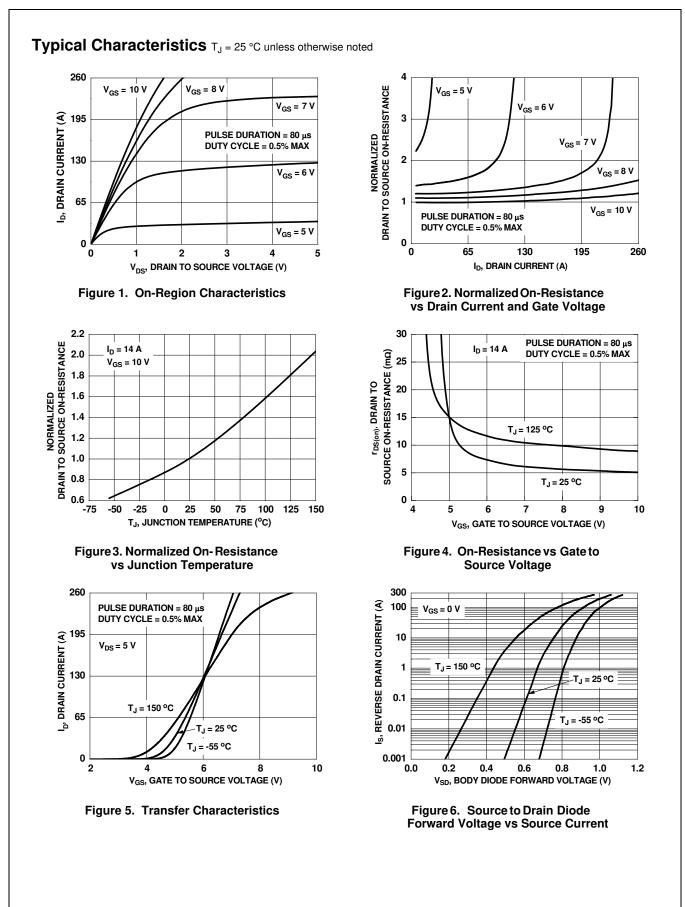


a. 45 °C/W when mounted on a 1 in² pad of 2 oz copper.



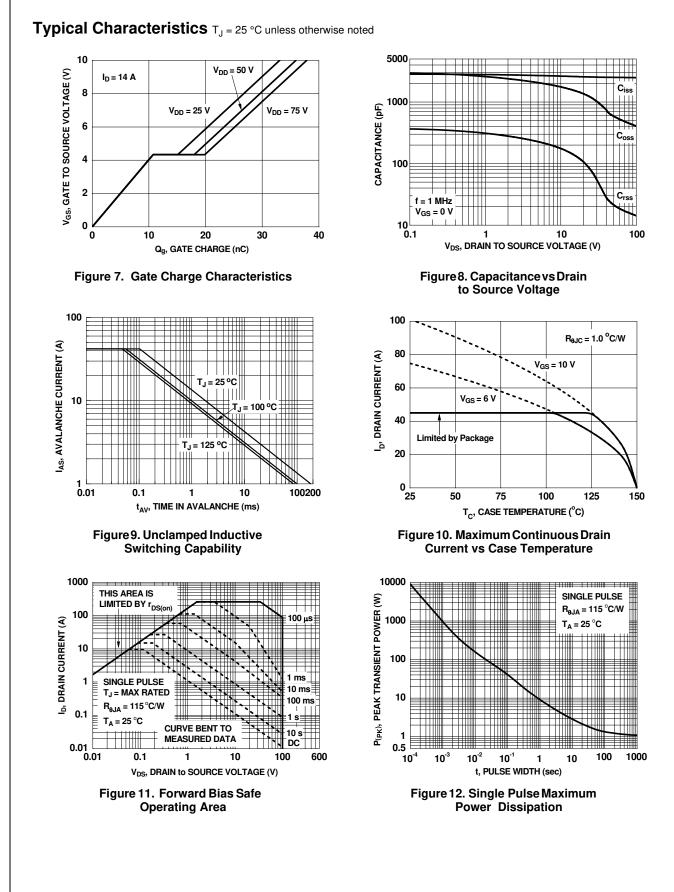
b. 115 °C/W when mounted on a minimum pad of 2 oz copper.

3. Starting T_J = 25 °C, L = 3 mH, I_{AS} = 19 A, V_{DD} = 100 V, V_{GS} = 10 V. 100% test at L = 0.3 mH, I_{AS} = 42 A.

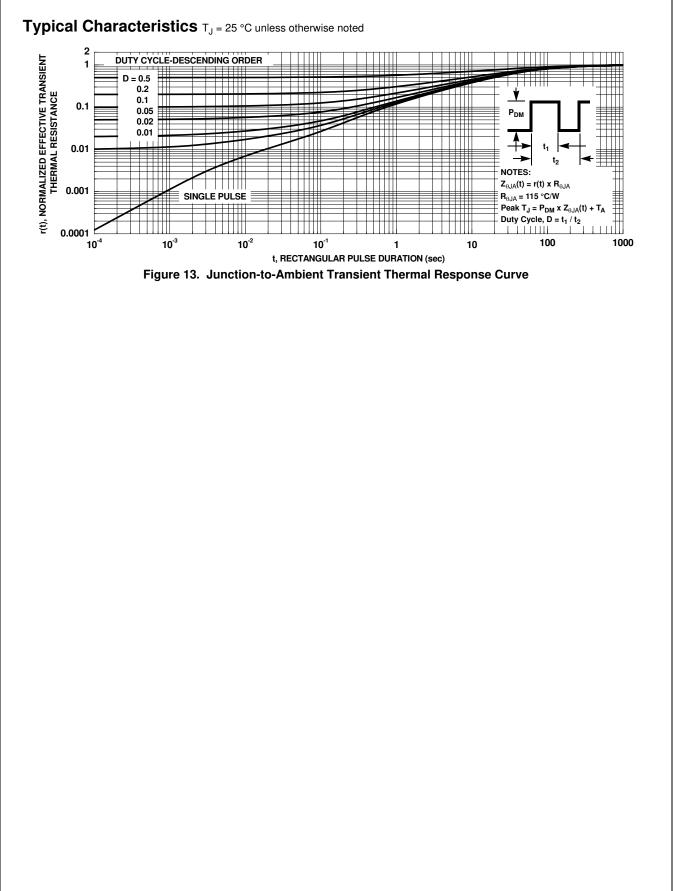


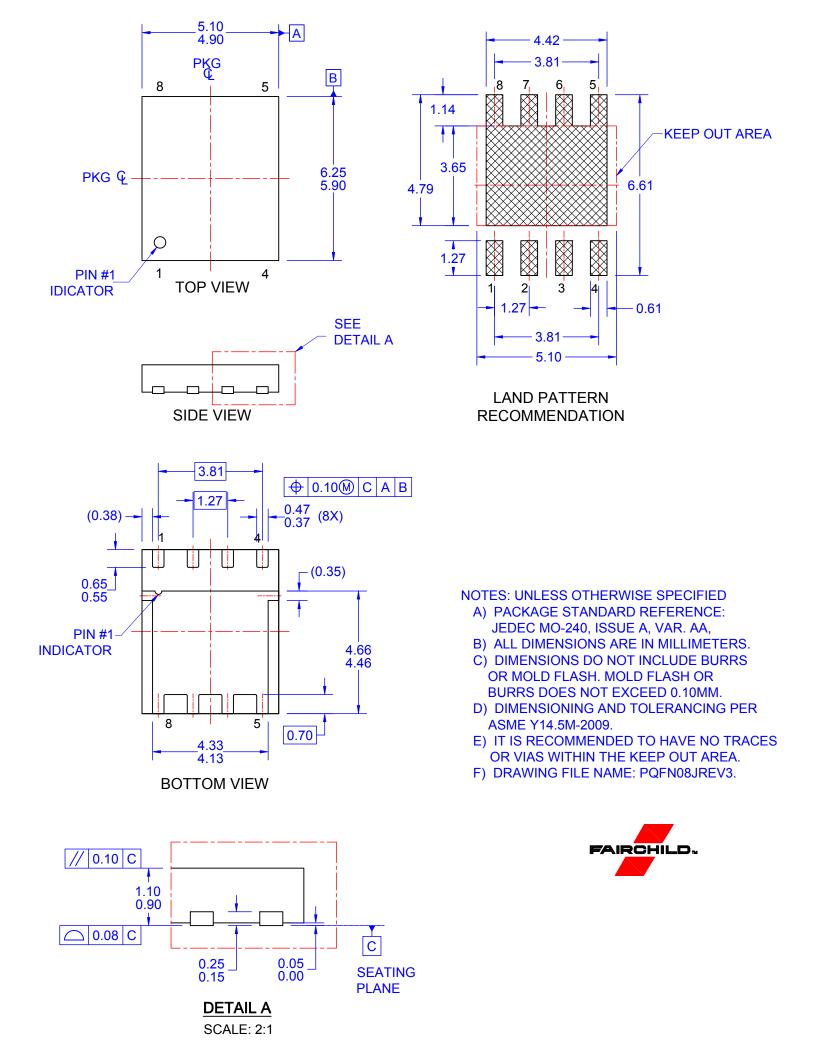
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